

OPTIREG™ linear voltage regulator TLS105B0MB

High precision voltage tracker



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Technical documents



Simulation



Family overview



Support



RoHS

Features

- 50 mA current capability
- Very high tracking accuracy
- Output voltage adjustable down to 2.0 V
- Stable with ceramic output capacitors
- Very low dropout voltage of typically 250 mV at 50 mA
- Very low current consumption of typically 3 μ A in standby mode
- Wide input voltage range $-16\text{ V} \leq V_{\text{IN}} \leq 45\text{ V}$
- Wide temperature range: $-40^{\circ}\text{C} \leq T_{\text{j}} \leq 150^{\circ}\text{C}$
- Short circuit protected output (to GND and to battery)
- Reverse polarity protected input
- Overtemperature protection
- Green Product (RoHS compliant)



Potential applications

- Automotive sensor supply
- Protected sensor supply for off-board sensors
- Secondary voltage supply for automotive ECU
- High precision voltage tracking
- Precision voltage replication
- Power switch for off-board load

Product validation

Qualified for automotive applications. Product validation according to AEC-Q100.

Description

The OPTIREG™ linear voltage regulator TLS105B0MB is a monolithic, integrated low-dropout voltage tracking regulator with high accuracy in small PG-SCT595-5 package. The TLS105B0MB is designed to supply off-board systems, for example sensors in powertrain management systems under the severe conditions of automotive applications. The TLS105B0MB provides protection functions against reverse polarity as well as against short circuit to GND and to battery. The output voltage follows the reference voltage applied to the EN/ADJ input with very high accuracy, up to a supply voltage of 40 V and up to an output current of 50 mA. The required minimum reference voltage at EN/ADJ is 2.0 V.

OPTIREG™ linear voltage regulator TLS105B0MB
High precision voltage tracker



Description

Type	Package	Marking
TLS105B0MB	PG-SCT595-5	05

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Block diagram

1 Block diagram

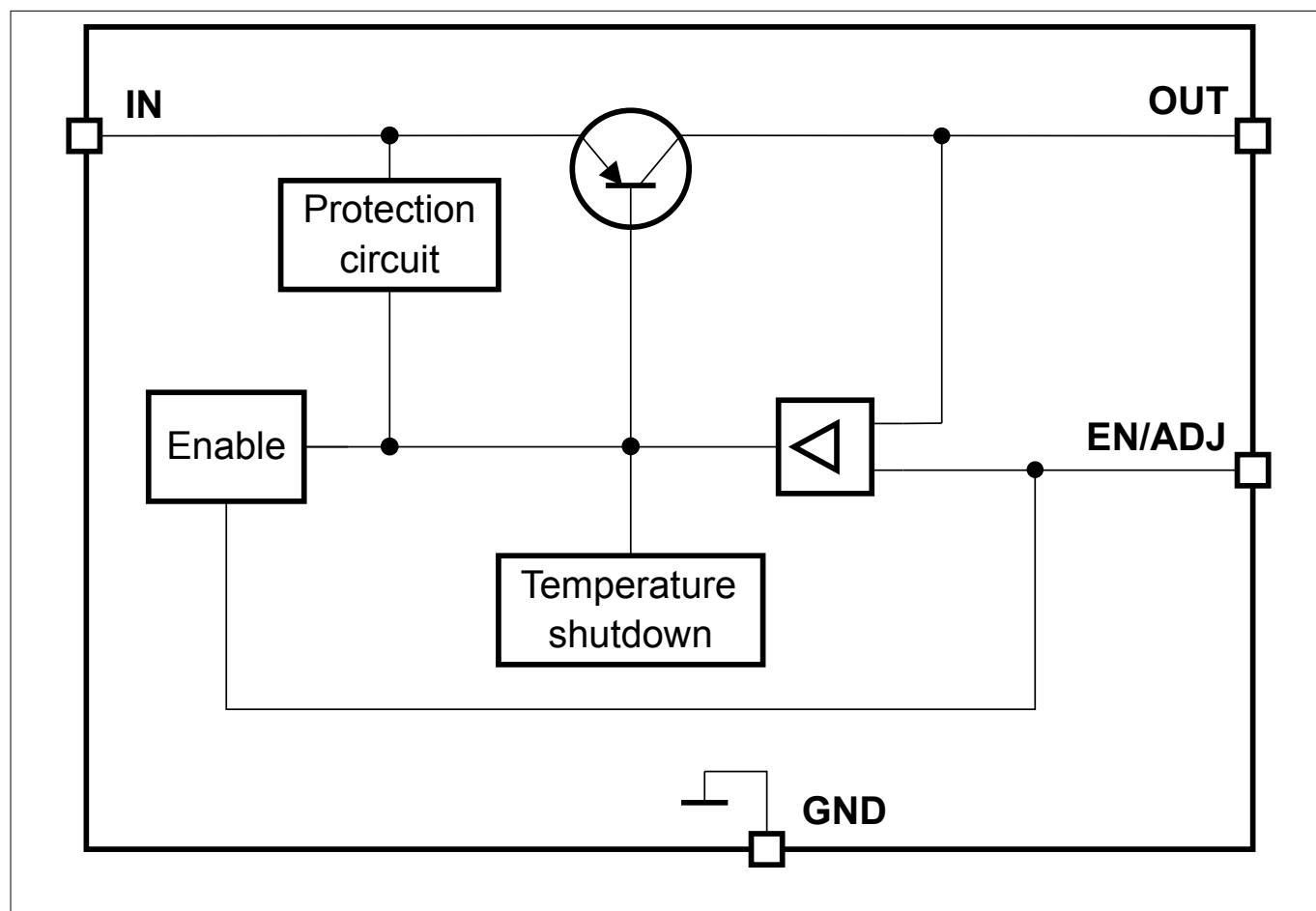


Figure 1 Block diagram

Pin configuration

2 Pin configuration

2.1 Pin assignment

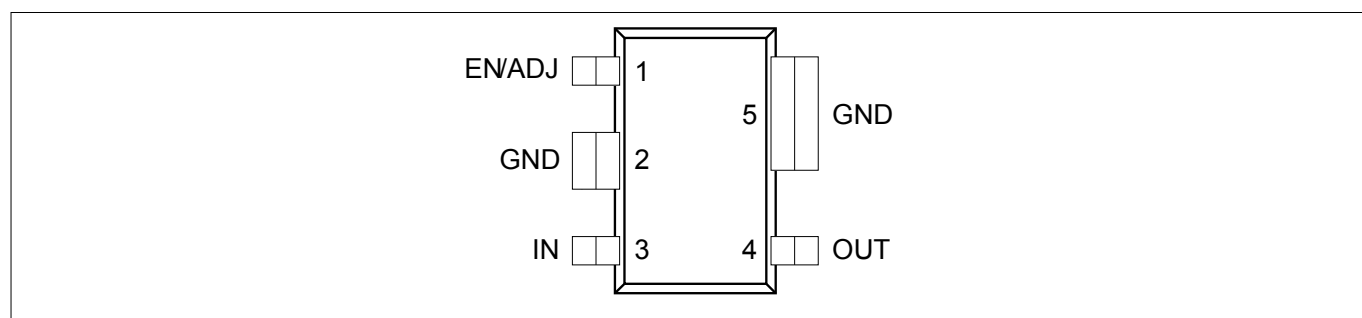


Figure 2 Pin configuration

2.2 Pin definitions and functions

Table 1 Pin definitions and functions

Pin	Symbol	Function
1	EN/ADJ	Enable/adjust: Connect the reference voltage to this pin. The reference voltage can be connected directly or via a voltage divider for lower output voltages. For the compensation of disturbances on the line, a capacitor close to the IC pins is recommended. "low" signal disables the device "high" signal enables the device
2	GND	Ground: Internally connected to pin 5. Connect to heatsink area.
3	IN	Input: Compensating line disturbances with a small ceramic capacitor to GND close to the IC terminals is recommended.
4	OUT	Tracker output: 50 mA output current capability Connect a capacitor to GND close to the pin, in accordance with capacitance and ESR requirements described in Table 3 .
5	GND	Ground: Internally connected to pin 2. Connect to heatsink area.

General product characteristics

3 General product characteristics

3.1 Absolute maximum ratings

Table 2 Absolute maximum ratings¹⁾

$T_j = -40^{\circ}\text{C}$ to 150°C ; all voltages with respect to ground, positive current flowing into pin
(unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or condition	Number
		Min.	Typ.	Max.			
Voltages							
Input voltage	V_{IN}	-16	–	45	V	–	P_3.1.1
Enable/Adjust voltage	$V_{\text{EN/ADJ}}$	-0.3	–	45	V	–	P_3.1.2
Output voltage	V_{OUT}	-5	–	45	V	–	P_3.1.3
Input output voltage difference	$V_{\text{IN}}-V_{\text{OUT}}$	-30	–	45	V	–	P_3.1.4
Temperatures							
Junction temperature	T_{j}	-40	–	150	°C	–	P_3.1.5
Storage temperature	T_{stg}	-55	–	150	°C	–	P_3.1.6
ESD susceptibility							
ESD susceptibility	$V_{\text{ESD,HBM}}$	-2	–	2	kV	²⁾ Human Body Model (HBM)	P_3.1.7
ESD susceptibility	$V_{\text{ESD,CDM}}$	-1	–	1	kV	³⁾ CDM	P_3.1.8
ESD susceptibility	$V_{\text{ESD,CDM}}$	-1	–	1	kV	³⁾ Charged Device Model (CDM) at corner pins	P_3.1.9

Notes:

1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability.
2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the datasheet. Fault conditions are considered as outside the normal operating range. Protection functions are not designed for continuous repetitive operation.

¹ Not subject to production test, specified by design.

² ESD susceptibility, HBM according to ANSI/ESDA/JEDEC JS001 (1.5k Ω , 100 pF)

³ ESD susceptibility, Charged Device Model (CDM) according to ESDA STM5.3.1 or ANSI/ESD S.5.3.1.

General product characteristics

3.2 Functional range

Table 3 Functional range

Parameter	Symbol	Values			Unit	Note or condition	Number
		Min.	Typ.	Max.			
Input voltage range	V_{IN}	4	–	40	V	–	P_3.2.1
Adjust input voltage range (Voltage tracking range)	V_{ADJ}	2	–	20	V	–	P_3.2.2
Capacitance of output capacitor	C_{OUT}	1	–	–	μF	⁴⁾	P_3.2.3
Equivalent series resistance of output capacitor	$ESR_{C_{OUT}}$	–	–	3	Ω	⁵⁾	P_3.2.4
Junction temperature	T_j	-40	–	150	°C	–	P_3.2.5

Note: Within the functional range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the electrical characteristics table.

3.3 Thermal resistance

Table 4 Thermal resistance⁶⁾

Parameter	Symbol	Values			Unit	Note or condition	Number
		Min.	Typ.	Max.			
Junction to ambient	R_{thJA}	–	84	–	K/W	⁷⁾	P_3.3.1
Junction to ambient	R_{thJA}	–	228	–	K/W	⁸⁾ Footprint only	P_3.3.2
Junction to ambient	R_{thJA}	–	123	–	K/W	⁸⁾ 300 mm ² PCB heatsink area	P_3.3.3
Junction to ambient	R_{thJA}	–	109	–	K/W	⁸⁾ 600 mm ² PCB heatsink area	P_3.3.4
Junction to soldering point	R_{thJSP}	–	32	–	K/W	Pins 2, 5 fixed to T_A	P_3.3.5

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information visit www.jedec.org.

⁴ The minimum output capacitance requirement is applicable for a worst case capacitance tolerance of 30%

⁵ Relevant ESR value at $f = 10$ kHz.

⁶ Not subject to production test, specified by design.

⁷ Specified R_{thJA} value is according to JEDEC JESD51-2,-5,-7 at natural convection on FR4 2s2p board; the product (chip and package) was simulated on a 76.2 × 114.3 × 1.5 mm³ board with two inner copper layers (2 × 70 μm Cu, 2 × 35 μm Cu). Where applicable, a thermal via array next to the package contacted the first inner copper layer.

⁸ Package mounted on PCB FR4; 80 × 80 × 1.5 mm³; 35 μm Cu, 5 μm Sn; horizontal position; zero airflow.

4 Block description and electrical characteristics

4.1 Functional description tracking regulator

The regulator controls the output voltage V_{OUT} by comparing it to the reference voltage applied to the EN/ADJ pin and driving a PNP pass transistor accordingly. The stability of the control loop depends on the following parameters:

- output capacitor C_{OUT}
- load current
- IC temperature
- poles and zeroes in the frequency response of the circuit including TLS105B0MB
- external circuitry

An input capacitor C_{IN} is strongly recommended to buffer disturbances on the line.

To ensure stable operation, the output capacitor's capacitance and its equivalent series resistance *ESR* must fulfill the requirements in [Table 3](#). The output capacitor must be sized suitably to buffer load transients.

Connect each capacitor close to the pins.

The internal protection features are designed to protect the device itself as well as the application from destruction in case of catastrophic events. These safeguards contain the following:

- Output current limitation
- Reverse polarity protection
- Thermal shutdown

Output current limitation

In order to protect the pass element and the package from excessive power dissipation, the device limits the maximum output current at high input voltage.

Reverse polarity protection

The device allows a negative supply voltage. However, in reverse polarity condition several small currents flowing into the device increase the junction temperature. Thermal design must consider this effect, because in reverse polarity condition the overtemperature protection circuit does not operate.

Thermal shutdown

The overtemperature protection circuit is designed to prevent immediate destruction of the device in certain fault conditions (for example a permanent short circuit at output) by switching off the power stage. After the chip cools down, the regulator restarts. If the fault is not removed, then this leads to an oscillatory behavior of the output voltage. A junction temperature above 150°C is outside the maximum ratings and reduces the lifetime of the device.

Block description and electrical characteristics

4.2 Electrical characteristics tracking regulator

Table 5 Electrical characteristics tracking regulator

$V_{IN} = 13.5 \text{ V}$, $2.0 \text{ V} \leq V_{EN/ADJ} \leq 20 \text{ V}$, $T_j = -40^\circ\text{C}$ to 150°C , all voltages with respect to ground, positive current flowing into pin (unless otherwise specified).

Parameter	Symbol	Values			Unit	Note or condition	Number
		Min.	Typ.	Max.			
Tracking output							
Output voltage tracking accuracy	ΔV_{OUT}	-5	–	5	mV	$\Delta V_{\text{OUT}} = V_{\text{ADJ}} - V_{\text{OUT}}$; $4\text{ V} \leq V_{\text{IN}} \leq 22\text{ V}$; $0.1\text{ mA} \leq I_{\text{OUT}} \leq 50\text{ mA}$; $2\text{ V} \leq V_{\text{EN/ADJ}} \leq V_{\text{IN}} - 0.5\text{ V}$; $V_{\text{EN/ADJ}} \leq 20\text{ V}$	P_4.1.1
Output voltage tracking accuracy	ΔV_{OUT}	-5	–	5	mV	$\Delta V_{\text{OUT}} = V_{\text{ADJ}} - V_{\text{OUT}}$; $4\text{ V} \leq V_{\text{IN}} \leq 32\text{ V}$; $0.1\text{ mA} \leq I_{\text{OUT}} \leq 25\text{ mA}$; $2\text{ V} \leq V_{\text{EN/ADJ}} \leq V_{\text{IN}} - 0.5\text{ V}$; $V_{\text{EN/ADJ}} \leq 20\text{ V}$	P_4.1.2
Output voltage tracking accuracy	ΔV_{OUT}	-5	–	5	mV	$\Delta V_{\text{OUT}} = V_{\text{ADJ}} - V_{\text{OUT}}$; $4\text{ V} \leq V_{\text{IN}} \leq 40\text{ V}$; $0.1\text{ mA} \leq I_{\text{OUT}} \leq 10\text{ mA}$; $2\text{ V} \leq V_{\text{EN/ADJ}} \leq V_{\text{IN}} - 0.5\text{ V}$; $V_{\text{EN/ADJ}} \leq 20\text{ V}$	P_4.1.3
Load regulation steady state	$\Delta V_{\text{OUT,load}}$	-3	–	–	mV	$I_{\text{OUT}} = 0.1\text{ mA}$ to 50 mA ; $V_{\text{EN/ADJ}} = 5\text{ V}$	P_4.1.4
Line regulation steady state	$\Delta V_{\text{OUT,line}}$	–	–	3	mV	$V_{\text{IN}} = 5.5\text{ V}$ to 32 V ; $I_{\text{OUT}} = 10\text{ mA}$; $V_{\text{EN/ADJ}} = 5\text{ V}$	P_4.1.5
Power supply ripple rejection	$PSRR$	–	100	–	dB	⁹⁾ $f_{\text{ripple}} = 100\text{ Hz}$; $V_{\text{ripple}} = 1\text{ V}_{\text{pp}}$; $I_{\text{OUT}} = 10\text{ mA}$; $C_{\text{OUT}} = 10\text{ }\mu\text{F}$, ceramic type	P_4.1.6
Output current limitation	$I_{\text{OUT,max}}$	51	85	120	mA	$V_{\text{OUT}} = V_{\text{ADJ}} - 0.1\text{ V}$; $V_{\text{EN/ADJ}} = 5\text{ V}$	P_4.1.7
Reverse current	$I_{\text{OUT,rev}}$	-1	-0.3	–	mA	$V_{\text{IN}} = 0\text{ V}$; $V_{\text{OUT}} = 16\text{ V}$; $V_{\text{EN/ADJ}} = 5\text{ V}$	P_4.1.10
Reverse current at negative input voltage	$I_{\text{IN,rev}}$	-8	-4	–	mA	$V_{\text{IN}} = -16\text{ V}$; $V_{\text{OUT}} = 0\text{ V}$;	P_4.1.11

(table continues...)

⁹⁾ Not subject to production test, specified by design.

Block description and electrical characteristics

Table 5 (continued) Electrical characteristics tracking regulator

$V_{IN} = 13.5 \text{ V}$, $2.0 \text{ V} \leq V_{EN/ADJ} \leq 20 \text{ V}$, $T_j = -40^\circ\text{C}$ to 150°C , all voltages with respect to ground, positive current flowing into pin (unless otherwise specified).

Parameter	Symbol	Values			Unit	Note or condition	Number
		Min.	Typ.	Max.			
						$V_{EN/ADJ} = 5 \text{ V}$	
Dropout voltage	V_{dr}	–	250	450	mV	¹⁰⁾ $V_{dr} = V_{IN} - V_{OUT}$; $I_{OUT} = 50 \text{ mA}$; $V_{EN/ADJ} = 5 \text{ V}$	P_4.1.12

Overtemperature protection⁹⁾

Overtemperature shutdown threshold	$T_{j,sd}$	–	175	–	$^\circ\text{C}$	T_j increasing due to power dissipation generated by the device	P_4.1.16
Overtemperature shutdown threshold hysteresis	$T_{j,sdh}$	–	15	–	$^\circ\text{C}$		P_4.1.17

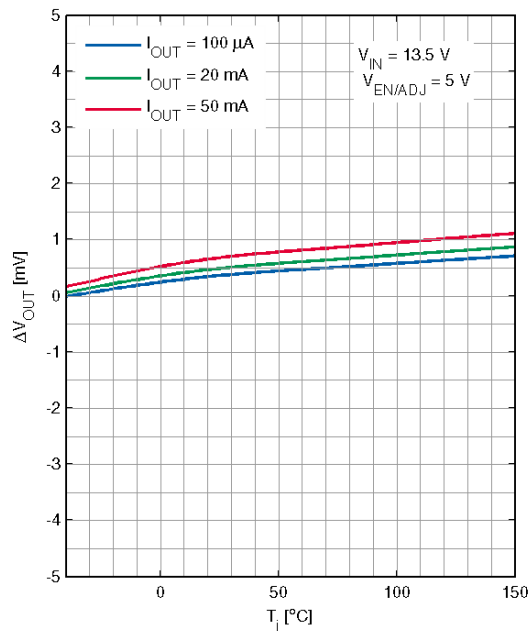
¹⁰⁾ Measured when the output voltage V_Q has dropped 100 mV from the nominal value obtained at $V_I = 13.5 \text{ V}$.

⁹⁾ Not subject to production test, specified by design.

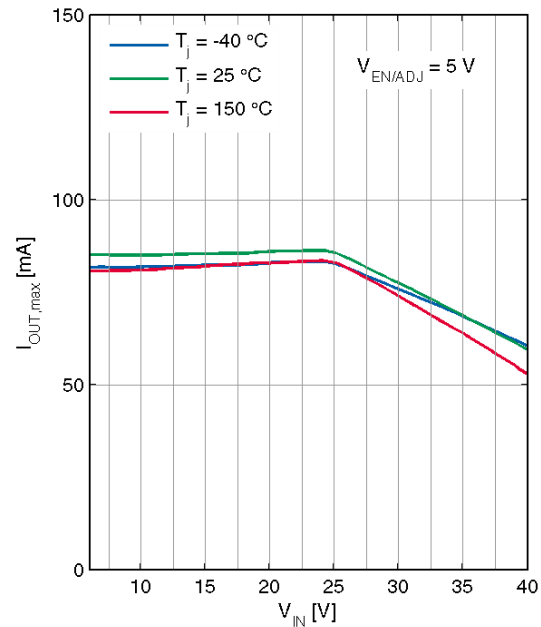
Block description and electrical characteristics

4.3 Typical performance characteristics tracking regulator

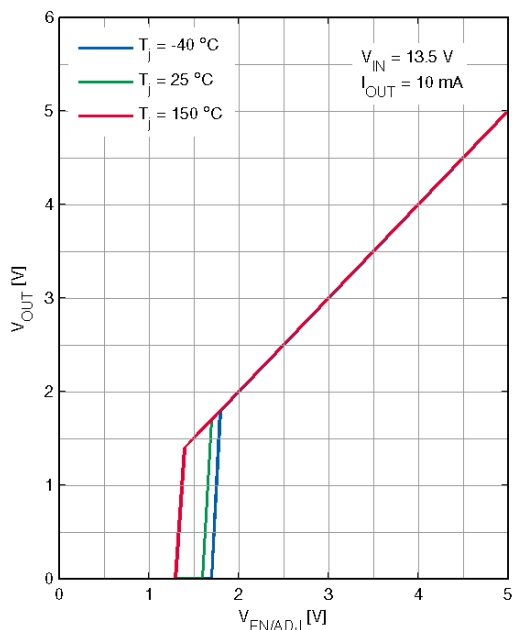
Tracking accuracy ΔV_{OUT} versus
 junction temperature T_j



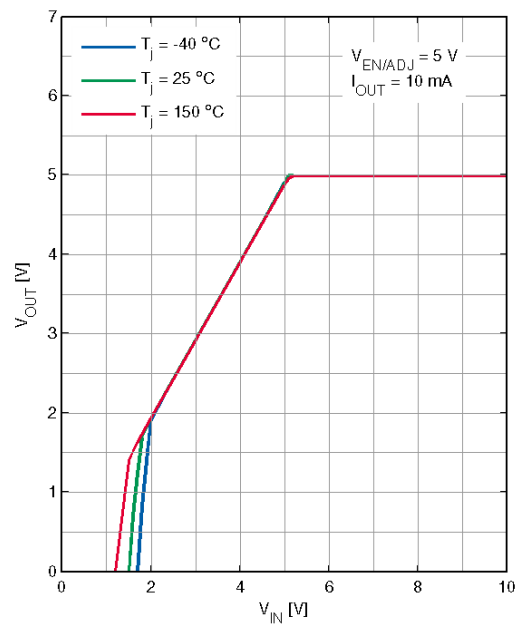
Output current limitation $I_{OUT,max}$ versus
 input voltage V_{IN}



Output voltage V_{OUT} versus
 enable/adjust voltage $V_{EN/ADJ}$

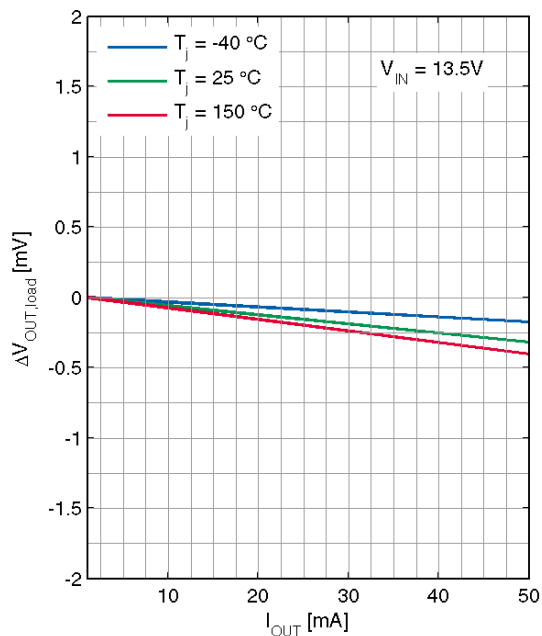


Output voltage V_{OUT} versus
 input voltage V_{IN}

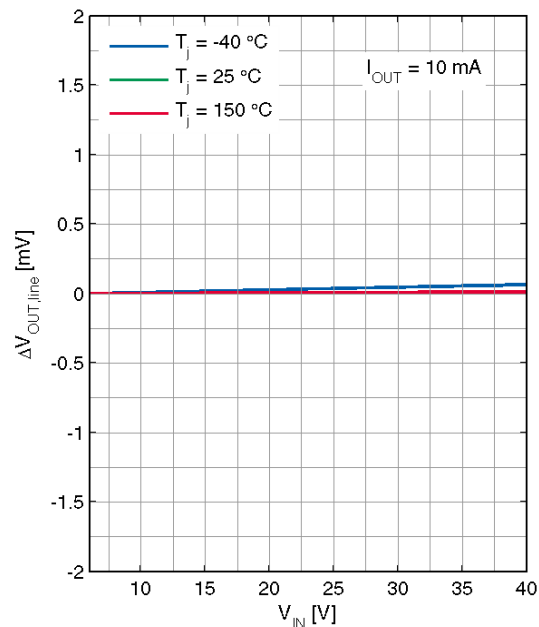


Block description and electrical characteristics

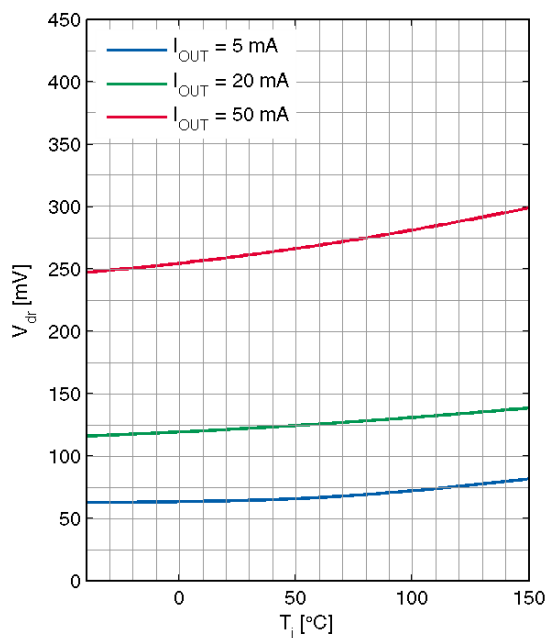
Load regulation $\Delta V_{OUT,load}$ versus
output current I_{OUT}



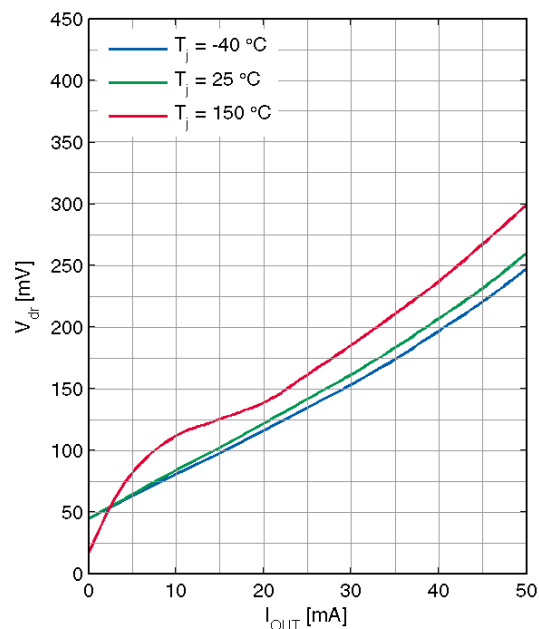
Line regulation $\Delta V_{OUT,line}$ versus
input voltage V_{IN}



Dropout voltage V_{dr} versus
junction temperature T_j

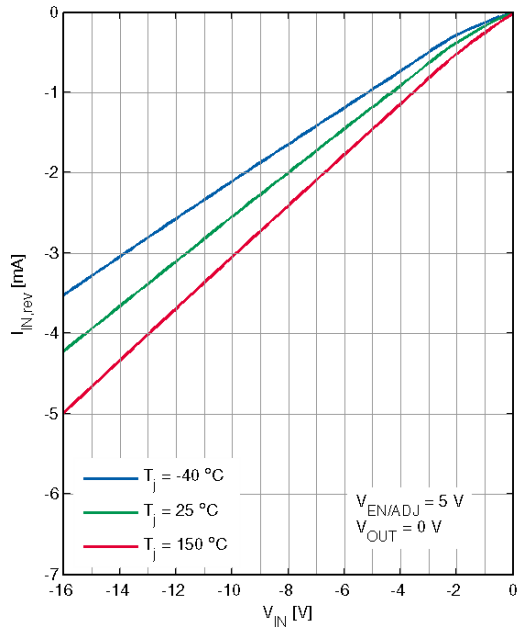


Dropout voltage V_{dr} versus
output current I_{OUT}

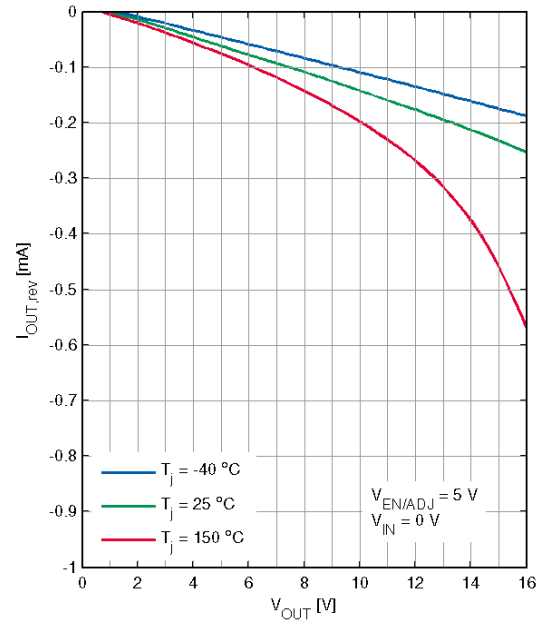


Block description and electrical characteristics

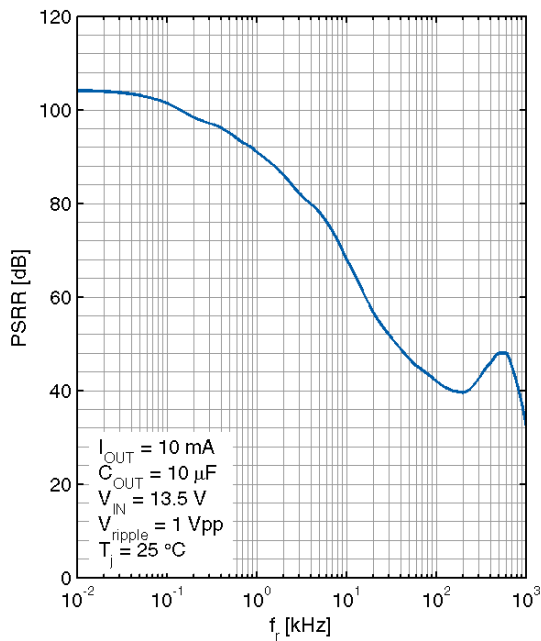
Reverse input current $I_{IN,rev}$ versus
input voltage V_{IN}



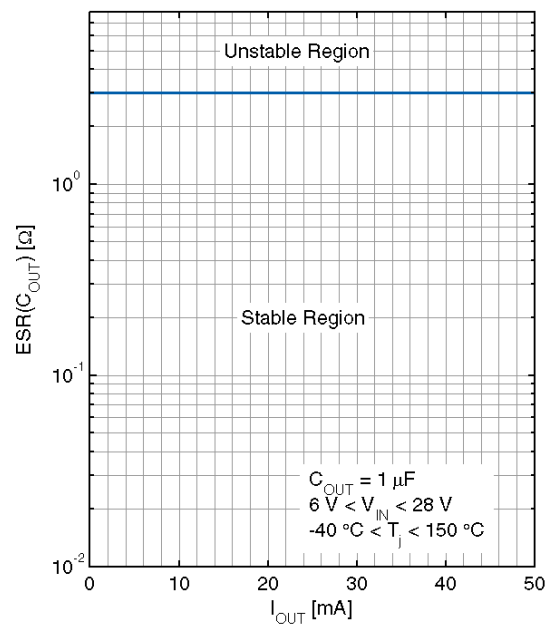
Reverse output current $I_{OUT,rev}$ versus
output voltage V_{OUT}



Power supply ripple rejection $PSRR$ versus
ripple frequency f_r



Output capacitor equivalent series resistance $ESR_{C_{OUT}}$
versus
output current I_{OUT}



Block description and electrical characteristics

4.4 Electrical characteristics current consumption

Table 6 Electrical characteristics current consumption

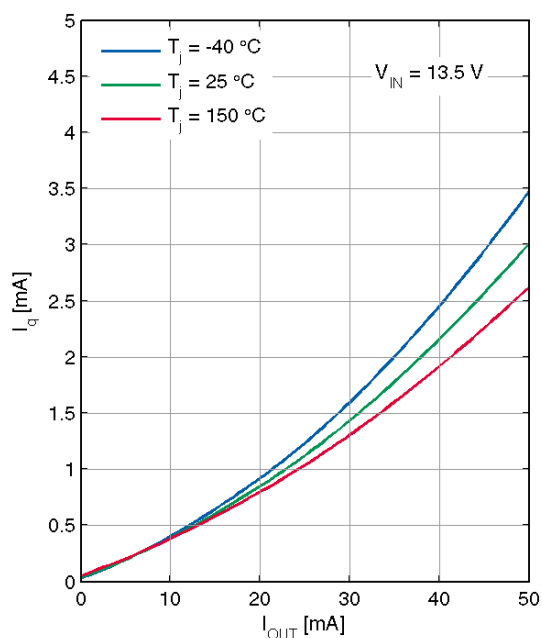
$V_{IN} = 13.5\text{ V}$, $2.0\text{ V} \leq V_{EN/ADJ} \leq 20\text{ V}$, $T_j = -40^\circ\text{C}$ to 150°C , all voltages with respect to ground, positive current flowing into pin (unless otherwise specified).

Parameter	Symbol	Values			Unit	Note or condition
		Min.	Typ.	Max.		
Current consumption stand-by mode	$I_{q,off}$	–	3	4.5	μA	$I_{q,off} = I_{IN}$; $V_{EN/ADJ} \leq 0.4\text{ V}$; $T_j \leq 125^\circ\text{C}$
Current consumption	I_q	–	40	75	μA	$I_q = I_{IN} - I_{OUT}$; $I_{OUT} \leq 0.1\text{ mA}$; $V_{EN/ADJ} = 5\text{ V}$; $T_j \leq 125^\circ\text{C}$
Current consumption	I_q	–	3	5.5	mA	$I_q = I_{IN} - I_{OUT}$; $I_{OUT} \leq 50\text{ mA}$; $V_{EN/ADJ} = 5\text{ V}$

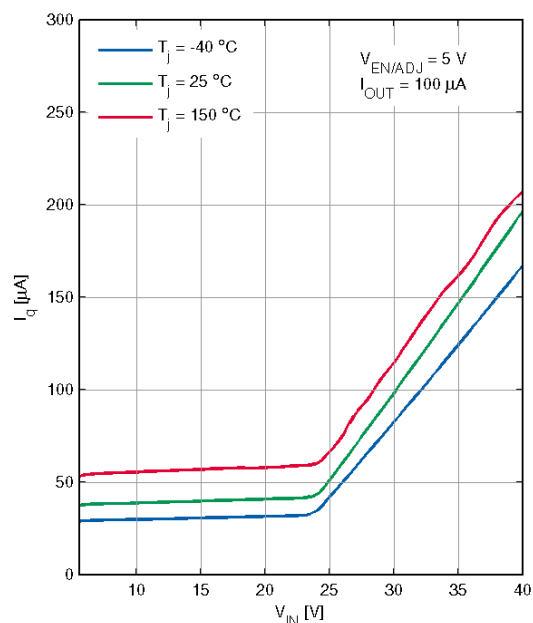
Block description and electrical characteristics

4.5 Typical performance characteristics current consumption

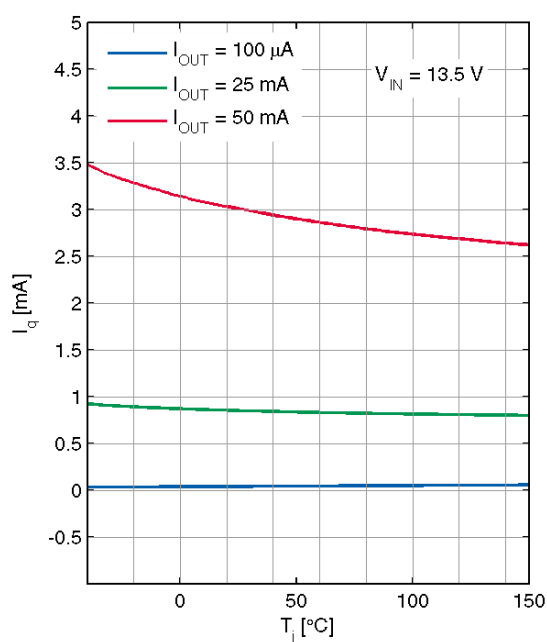
Current consumption I_q versus
output current I_{OUT}



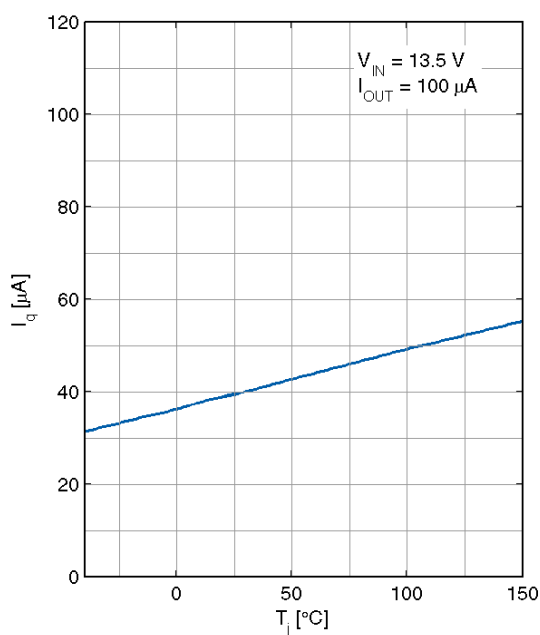
Current consumption I_q versus
input voltage V_{IN}



Current consumption I_q versus
junction temperature T_j

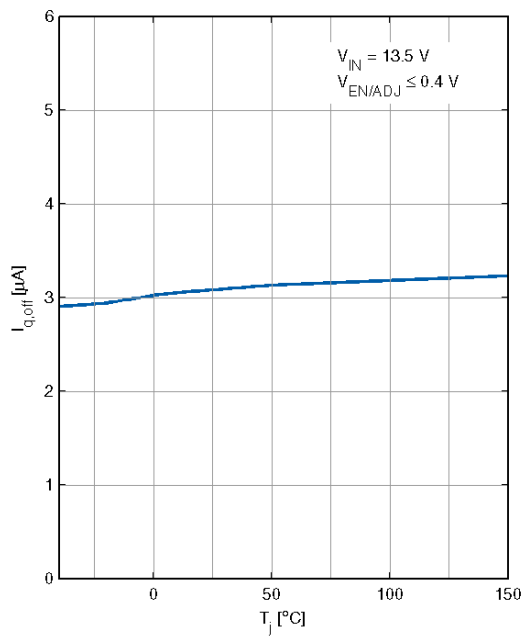


Current consumption I_q versus
junction temperature T_j (I_{OUT} low)



Block description and electrical characteristics

Current consumption in OFF mode $I_{q,off}$ versus
junction temperature T_j



Block description and electrical characteristics

4.6 Functional description enable/adjust input

On a “low” signal at the enable/adjust input EN/ADJ the device switches to standby mode in order to minimize the quiescent current.

If the EN/ADJ pin is not connected, then the “low” level from the internal pull-down resistor switches off the regulator.

4.7 Electrical characteristics enable/adjust input

Table 7 Electrical characteristics enable/adjust input

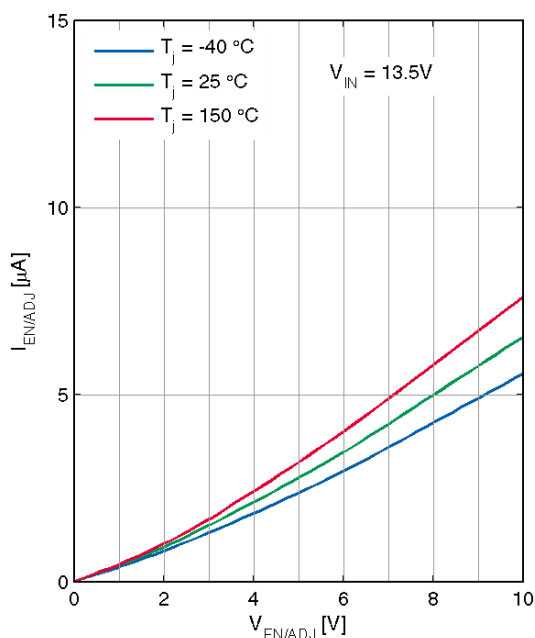
$V_{IN} = 13.5\text{ V}$, $2.0\text{ V} \leq V_{EN/ADJ} \leq 20\text{ V}$, $T_j = -40^\circ\text{C}$ to 150°C , all voltages with respect to ground, positive current flowing into pin (unless otherwise specified).

Parameter	Symbol	Values			Unit	Note or condition
		Min.	Typ.	Max.		
Enable/adjust off voltage range	$V_{EN/ADJ,off}$	–	–	0.8	V	$V_{OUT} = 0\text{ V}$
Enable/adjust on voltage range	$V_{EN/ADJ,on}$	2	–	–	V	V_{OUT} settled
Enable/adjust input current	$I_{EN/ADJ}$	–	3	5	μA	$V_{EN/ADJ} = 5\text{ V}$

Block description and electrical characteristics

4.8 Typical performance characteristics enable/adjust input

Enable/adjust input current $I_{\text{EN/ADJ}}$ versus
input voltage $V_{\text{EN/ADJ}}$



5 Application information

Note: The following information is given as an example for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

5.1 Application diagram

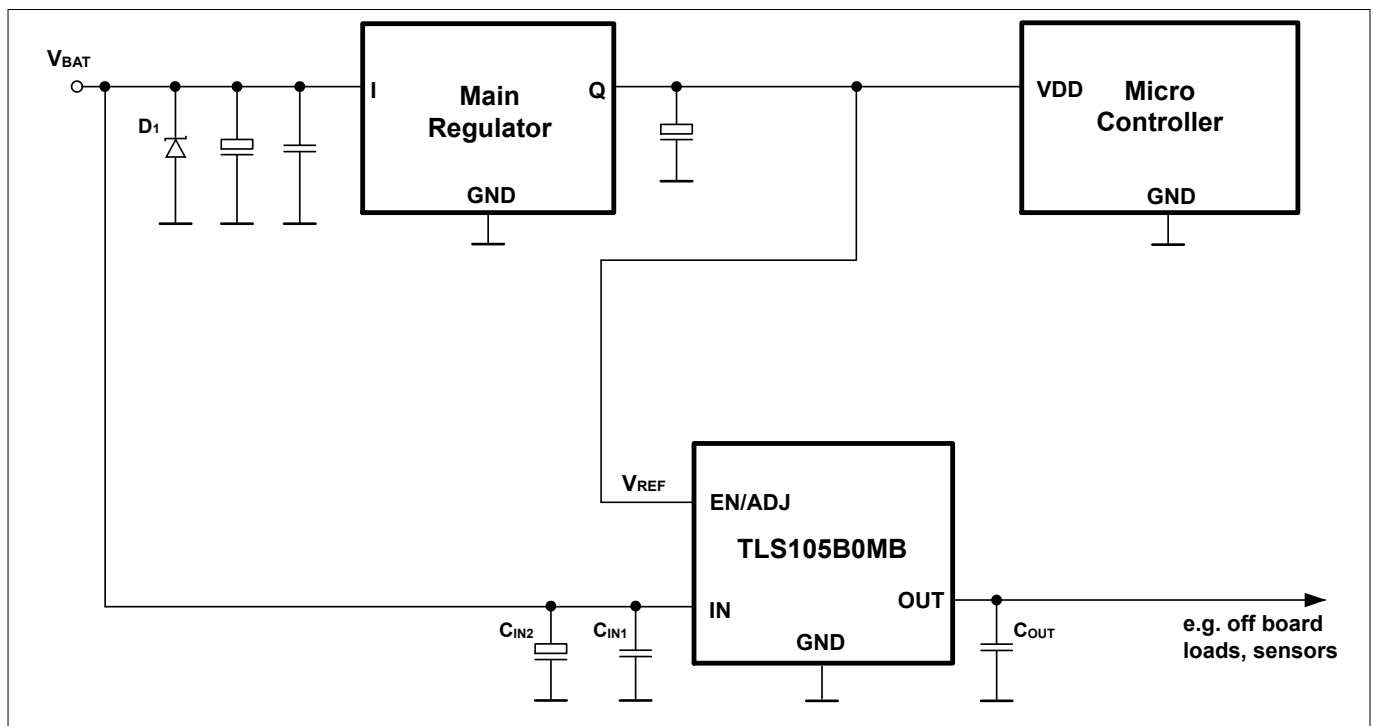


Figure 3 Application circuit

Note: This figure is a simplified example of an application circuit. The function must be verified in the application.

5.2 Selection of external components

5.2.1 Input pin

Figure 3 shows a typical input circuitry for a voltage tracking regulator. The following external components at the input are recommended in case of possible external disturbance.

Ceramic capacitor

A ceramic capacitor C_{IN1} (100 nF to 470 nF) at the input filters high frequency disturbance imposed by the line, such as ISO pulses 3a/b. Place C_{IN1} as close as possible to the input pin of the voltage tracking regulator on the PCB.

Application information

Aluminum electrolytic capacitor

An aluminum electrolytic capacitor C_{IN2} (10 μ F to 470 μ F) at the input smoothens high energy pulses, such as ISO pulse 2a. Place C_{IN2} close to the input pin of the voltage tracking regulator on the PCB.

Overvoltage suppression diode

A suitably sized diode D_1 suppresses high voltage beyond the maximum ratings of the circuit components and protects the device from damage due to overvoltage.

5.2.2 Output pin

An output capacitor C_{OUT} is necessary for the stability of the voltage tracking regulator, see [Table 3](#). The typical performance graph [Output capacitor equivalent series resistance \$ESR_{C_{OUT}}\$ versus output current \$I_{OUT}\$](#) shows the stable operating range of the device.

In an automotive environment, ceramic capacitors with X5R or X7R dielectrics are recommended.

Place C_{OUT} on the same side of the PCB as the device and as close as possible to both the OUT pin and the GND pin.

In case of rapid transients of the input voltage or of the load current, C_{OUT} must be dimensioned properly to ensure the output stability in the application.

5.2.3 Enable/Adjust pin

[Figure 3](#) shows the typical input circuitry for a voltage tracking regulator. Typically the enable/adjust pin is connected to a fixed voltage reference that the regulator tracks. In the example of the application diagram EN/ADJs is connected to the supply voltage of a microcontroller. Alternatively, the voltage reference can also be adjusted by a voltage divider.

5.3 Thermal considerations

Knowing the input voltage, the output voltage and the load profile of the application, the total power dissipation can be calculated by:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_q$$

Equation 1

with

- P_D : continuous power dissipation
- V_{IN} : input voltage
- V_{OUT} : output voltage
- I_{OUT} : output current
- I_q : quiescent current

The maximum acceptable thermal resistance R_{thJA} can then be calculated by:

$$R_{thJA, \max} = \frac{T_{j, \max} - T_a}{P_D}$$

Equation 2

with

Application information

- $T_{j,max}$: maximum allowed junction temperature
- T_a : ambient temperature

Based on the above calculation the proper PCB type and the necessary heat sink area can be determined with reference to the specification in [Table 4](#).

Example

Application conditions:

- $V_{IN} = 13.5 \text{ V}$
- $V_{OUT} = V_{ADJ} = 5 \text{ V}$
- $I_{OUT} = 20 \text{ mA}$
- $T_a = 125^\circ\text{C}$

Calculation of $R_{thJA,max}$:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_q = (13.5 \text{ V} - 5 \text{ V}) \times 20 \text{ mA} + 13.5 \text{ V} \times 0.9 \text{ mA} = 0.182 \text{ W}$$

Equation 3

$$R_{thJA, max} = \frac{T_{j,max} - T_a}{P_D} = \frac{150^\circ\text{C} - 125^\circ\text{C}}{0.182 \text{ W}} = 137 \text{ K/W}$$

Equation 4

As a result, the PCB design must ensure a thermal resistance $R_{thJA,max}$ lower than 137 K/W.

According to [Table 4](#), at least 300 mm² heatsink area is required on the FR4 1s0p PCB, or the FR4 2s2p board can be used.

6 Package information

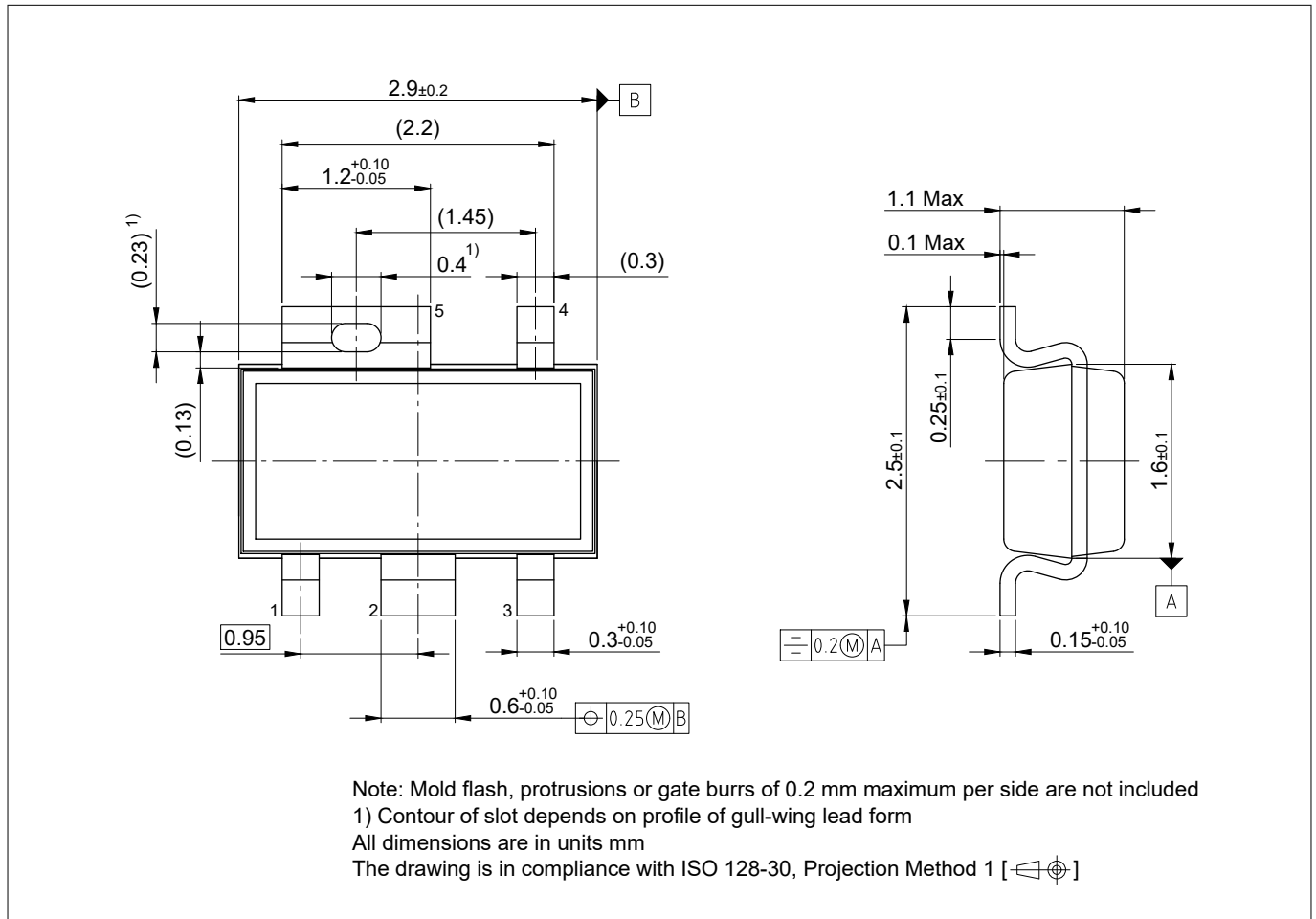


Figure 4 PG-SCT595-5

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a Green Product. Green Products are RoHS compliant (Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Information on alternative packages

Please visit www.infineon.com/packages.

Revision history

Revision history

Revision	Date	Changes
1.12	2021-05-28	Editorial changes
1.11	2020-10-12	Editorial changes
1.1	2018-07-31	Datasheet updated: - Package outline drawing: - algebraic sign "+" → "-" for some tolerance values - add pin 1 to pin 3 distance - Editorial changes
1.0	2018-01-22	Datasheet created

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